

P-Channel 20V P MOSFETs

Description

These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

Features

- -20V,-5.8A, RDS(ON) =33m Ω @VGS = -4.5V
- Improved dv/dt capability
- Green Device Available
- 100% EAS Guaranteed
- Fast Switching
- RoHS compliant package

Application

- Notebook
- · Load Switch
- Battery Protection
- Hand-held Instruments

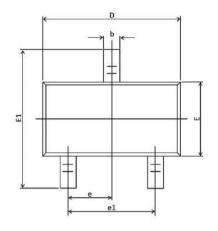
Package type: SOT23-3S

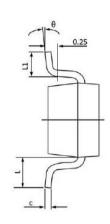
Packing & Order information

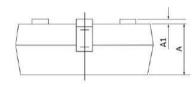
3,000/Reel





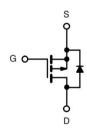






Crombal	Dimensions I	n Millimeters	Dimension	s In Inches
Symbol	Min	Max	Min	Max
A	0.900	1.000	0.035	0.039
A1	0.000	0.100	0.000	0.004
b	0.300	0.500	0.012	0.020
c	0.090	0.110	0.003	0.004
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037	TYP.
e1	1.800	2.000	0.071	0.079
L	0.550	REF.	0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	1°	7°	1°	7°

`Graphic symbol



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings (Tc=25°C unless otherwise specified)						
Symbol	Parameter	Value	Unit			
V_{DS}	Drain to Source Voltage	-20	V			
V_{GS}	Gate to Source Voltage	±10	V			
I_D	Continuous Drain Current (TC=25°C)	-5.8	A			
	Continuous Drain Current (TC=100°C)	-3.7	11			
I_{DM}	Drain Current Pulsed ¹	-23.2	A			



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Absolute Maximum Ratings (Tc=25°C unless otherwise specified)						
Symbol	Parameter Value Unit					
P_D	Power Dissipation (TC = 25° C)	1.56	W			
	Power Dissipation – Derate above 25°C	0.012	W/°C			
Tstg	Storage Temperature Range	-55 to +150	°C			
T _J	Operating Junction Temperature Range	-55 to +150	°C			

Thermal Characteristics						
Symbol	Parameter		Value			
		Min.	Typ.	Max.	Units	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient			80	°C/W	

Electrical Characteristics (TJ=25°C, unless otherwise noted)

Off Characteristics							
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units	
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0 V , I_D = 250 μA	-60			V	
ΔBV_{DSS} $/\Delta T_J$	BV _{DSS} Temperature Coefficient	I _D = -1 mA, Referenced to 25°C		-0.05		V/°C	
I _{DS S}	Drain-Source Leakage Current	$V_{DS} = -20 \text{ V}, T_J = 25^{\circ}\text{C}$ $V_{DS} = -16 \text{ V}, T_J = 125^{\circ}\text{C}$			-1 -10	uA	
I_{GSS}	Gate-Source Leakage, Forward	$V_{GS}=\pm 10~V~,~V_{DS}=0~V$			±100	nA	

On Characteristics						
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \text{ uA}$	-0.3	-0.6	-1	V
R _{DS} (ON)	Static Drain-Source On-state Resis-tance	$V_{GS} = -4.5 \text{ V}$, $I_D = -4 \text{ A}$		28	33	
		$V_{GS} = -2.5 \text{ V}, I_D = -3 \text{ A}$		37	45	mΩ
		$V_{GS} = -1.8 \text{ V}, I_D = -2 \text{ A}$		49	65	
$\Delta V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{GS}, I_D = 250 \text{ uA}$		2		mV/°C
gfs	Forward Transconductance	$V_{DS} = -10V$, $I_S = -3$ A		8.4		S

Dynamic Characteristics							
Symbol	Parameter	Test Conditions	Min	Тур.	Max.	Units	
Qg	Total Gate Charge ^{2,3}	$V_{DS} = -10 \text{ V},$		16.1	25	nC	
Q_{gs}	Gate-Source Charge ^{2,3}	$V_{GS} = -4.5 \text{ V},$		1.8	3	nC	
Qgd	Gate-Drain Charge ^{2,3}	$I_D = -4 A$		3.8	7	nC	
Ciss	Input Capacitance	$V_{GS} = 0 V$,		1440	2100	pF	
Coss	Output Capacitance	$V_{DS} = -15 \text{ V},$		155	230	pF	
C _{RSS}	Reverse Transfer Capacitance	f = 1 MHz		115	170	pF	



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Drain-Source Diode Characteristics and Maximum Ratings							
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units	
Is	Continuous Source Current	$V_D=V_G=0V$			-5.8	A	
I _{SM}	Pulsed Source Current	Force Current			-23.2	A	
V_{SD}	Diode Forward Voltage	$I_S = -1 A, V_{GS} = 0 V, TJ = 25 ^{\circ}C$			-1	V	

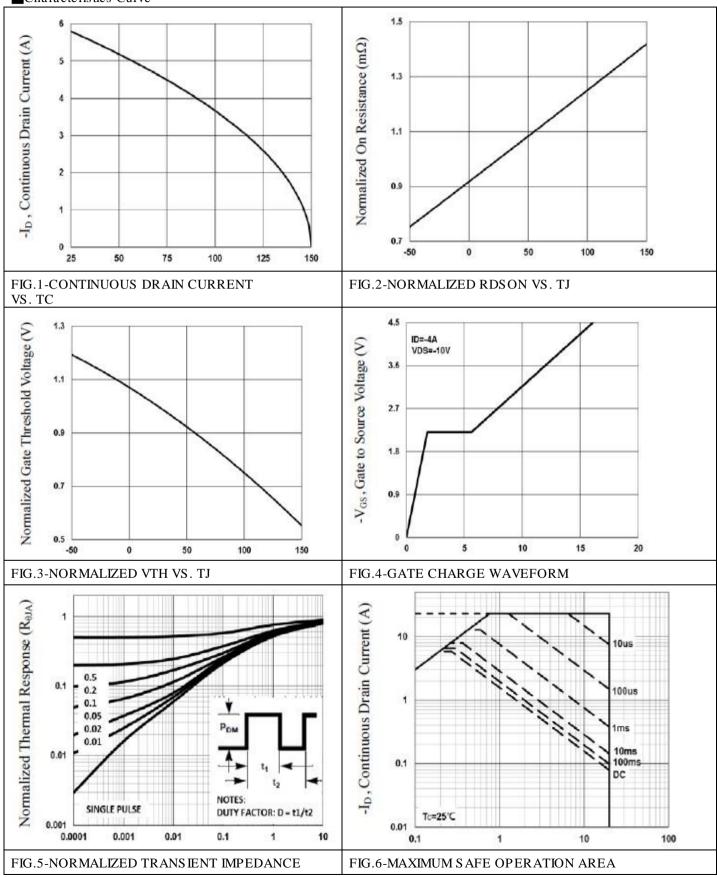
Note:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. The data tested by pulsed, pulse width ≤ 300 us, duty cycle $\leq 2\%$.
- 3. Essentially independent of operating temperature.



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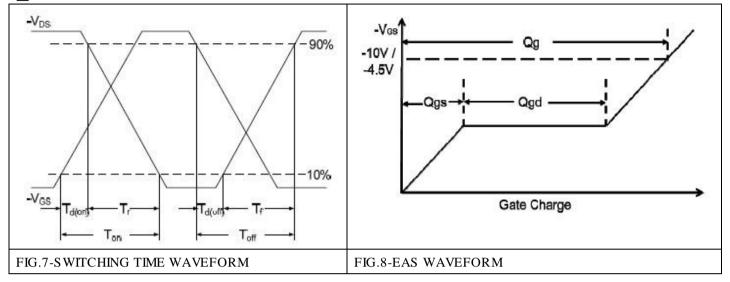
Characteristics Curve





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Characteristics Curve





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